

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>SHIVANK NAYAK</td> <td>02/10/2014</td> </tr> <tr> <td>AJEET KUMAR</td> <td>02/11/2014</td> </tr> <tr> <td>RAJESH MADHUKAR PATIL</td> <td>02/11/2014</td> </tr> </tbody> </table>		Name	Execution Date	SHIVANK NAYAK	02/10/2014	AJEET KUMAR	02/11/2014	RAJESH MADHUKAR PATIL	02/11/2014
Name	Execution Date								
SHIVANK NAYAK	02/10/2014								
AJEET KUMAR	02/11/2014								
RAJESH MADHUKAR PATIL	02/11/2014								
RECEIVING PARTY DATA									
Name:	QUALCOMM INCORPORATED								
Street Address:	5775 MOREHOUSE DRIVE								
City:	SAN DIEGO								
State/Country:	CALIFORNIA								
Postal Code:	92121-1714								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14188796</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14188796				
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Application Number:	14188796								
CORRESPONDENCE DATA									
Fax Number:	(703)391-2901								
Phone:	7033912900								
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<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>									
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Address Line 2:	15TH FLOOR								
Address Line 4:	RESTON, VIRGINIA 20191								
ATTORNEY DOCKET NUMBER:	133910 / 1376-1324								
NAME OF SUBMITTER:	ROBERT M. HANSEN								
Signature:	/Robert M. Hansen/								

Date:

02/25/2014

Total Attachments: 6

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ASSIGNMENT

WHEREAS, WE,

1. **Shivank Nayak**, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, and a resident of San Diego, CA;
2. **Ajeet Kumar**, a citizen of India, having a mailing address located at Bldg 9, 14th & 15th Floors Mindspace HiTec City Rd Madhapur Hyderabad, Andhra Pradesh, India 500081, and a resident of Hyderabad, India; and
3. **Rajesh Madhukar Patil**, a citizen of India, having a mailing address located at Bldg 9, 14th & 15th Floors Mindspace HiTec City Rd Madhapur Hyderabad, Andhra Pradesh, India 500081, and a resident of Hyderabad, India;

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **SYSTEM AND METHODS FOR IMPROVING NETWORK REGISTRATION FOR ALL SIMS OF A MULTI-SIM DEVICE USING A DYNAMICALLY-DETERMINED REGISTRATION ORDER** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/188,796 filed Feb. 25, 2014 Qualcomm Reference No. 133910, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

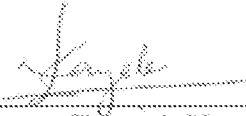
AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, on 02/10/2014
LOCATION DATE

Shivank Nayak

Done at _____, on _____
LOCATION DATE
Ajeet Kumar

Done at _____, on _____
LOCATION DATE
Rajesh Madhukar Patil

ASSIGNMENT

WHEREAS, WE,

1. **Shivank Nayak**, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, and a resident of San Diego, CA;
2. **Ajeet Kumar**, a citizen of India, having a mailing address located at Bldg 9, 14th & 15th Floors Mindspace HiTec City Rd Madhapur Hyderabad, Andhra Pradesh, India 500081, and a resident of Hyderabad, India; and
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have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **SYSTEM AND METHODS FOR IMPROVING NETWORK REGISTRATION FOR ALL SIMS OF A MULTI-SIM DEVICE USING A DYNAMICALLY-DETERMINED REGISTRATION ORDER** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/188,796 filed Feb 25 2014 Qualcomm Reference No. 133910, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
LOCATION DATE Shivank Nayak

Done at HYDERABAD, on 11/02/2014
LOCATION DATE Ajeet Kumar

Done at HYDERABAD, on 11/02/2014
LOCATION DATE Rajesh Madhukar Patil